

## PRODUCT FEATURES

- IGBT chip in trench FS-technology
- Low switching losses
- $V_{CE(sat)}$  with positive temperature coefficient
- Fast switching and short tail current
- Free wheeling diodes with fast and soft reverse recovery



## APPLICATIONS

- Welding Machine
- Power Supplies
- Others

### IGBT-inverter

ABSOLUTE MAXIMUM RATINGS ( $T_C=25^\circ\text{C}$  unless otherwise specified)

Symbol	Parameter/Test Conditions		Values	Unit
$V_{CES}$	Collector Emitter Voltage	$T_J=25^\circ\text{C}$	1200	V
$V_{GES}$	Gate Emitter Voltage		$\pm 20$	
$I_C$	DC Collector Current	$T_C=25^\circ\text{C}, T_{Jmax}=175^\circ\text{C}$	231	A
		$T_C=100^\circ\text{C}, T_{Jmax}=175^\circ\text{C}$	150	
$I_{CM}$	Repetitive Peak Collector Current	$tp=1\text{ms}$	300	
$P_{tot}$	Power Dissipation Per IGBT	$T_C=25^\circ\text{C}, T_{Jmax}=175^\circ\text{C}$	937	W

### Diode-inverter

ABSOLUTE MAXIMUM RATINGS ( $T_C=25^\circ\text{C}$  unless otherwise specified)

Symbol	Parameter/Test Conditions		Values	Unit
$V_{RRM}$	Repetitive Reverse Voltage	$T_J=25^\circ\text{C}$	1200	V
$I_{F(AV)}$	Average Forward Current		150	A
$I_{FRM}$	Repetitive Peak Forward Current	$tp=1\text{ms}$	300	
$I^2t$		$T_J=125^\circ\text{C}, t=10\text{ms}, V_R=0\text{V}$	5000	$\text{A}^2\text{S}$

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# MMG150D120B6UC

## IGBT-inverter

### ELECTRICAL CHARACTERISTICS ( $T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit	
$V_{GE(th)}$	Gate Emitter Threshold Voltage	$V_{CE}=V_{GE}, I_C=6\text{mA}$	5.2	6.0	6.5	V	
$V_{CE(sat)}$	Collector Emitter Saturation Voltage	$I_C=150\text{A}, V_{GE}=15\text{V}, T_J=25^\circ\text{C}$		1.7	2.15		
		$I_C=150\text{A}, V_{GE}=15\text{V}, T_J=125^\circ\text{C}$		1.95			
		$I_C=150\text{A}, V_{GE}=15\text{V}, T_J=150^\circ\text{C}$		2.0			
$I_{CES}$	Collector Leakage Current	$V_{CE}=1200\text{V}, V_{GE}=0\text{V}, T_J=25^\circ\text{C}$			100	$\mu\text{A}$	
		$V_{CE}=1200\text{V}, V_{GE}=0\text{V}, T_J=150^\circ\text{C}$			1	$\text{mA}$	
$I_{GES}$	Gate Leakage Current	$V_{CE}=0\text{V}, V_{GE}=\pm 20\text{V}, T_J=25^\circ\text{C}$	-400		400	$\text{nA}$	
$R_{gint}$	Integrated Gate Resistor			3.8		$\Omega$	
$Q_g$	Gate Charge	$V_{CE}=600\text{V}, I_C=150\text{A}, V_{GE}=15\text{V}$		1		$\mu\text{C}$	
$C_{ies}$	Input Capacitance	$V_{CE}=25\text{V}, V_{GE}=0\text{V}, f=1\text{MHz}$		14.6		$\text{nF}$	
$C_{res}$	Reverse Transfer Capacitance				660		$\text{pF}$
$t_{d(on)}$	Turn on Delay Time	$V_{CC}=600\text{V}, I_C=150\text{A}$ $R_G=3.6\Omega,$ $V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$	110		$\text{ns}$	
			$T_J=125^\circ\text{C}$	130		$\text{ns}$	
			$T_J=150^\circ\text{C}$	145		$\text{ns}$	
$t_r$	Rise Time		$T_J=25^\circ\text{C}$	58		$\text{ns}$	
			$T_J=125^\circ\text{C}$	62		$\text{ns}$	
			$T_J=150^\circ\text{C}$	64		$\text{ns}$	
$t_{d(off)}$	Turn off Delay Time	$T_J=25^\circ\text{C}$	410		$\text{ns}$		
		$T_J=125^\circ\text{C}$	460		$\text{ns}$		
		$T_J=150^\circ\text{C}$	480		$\text{ns}$		
$t_f$	Fall Time	$T_J=25^\circ\text{C}$	70		$\text{ns}$		
		$T_J=125^\circ\text{C}$	100		$\text{ns}$		
		$T_J=150^\circ\text{C}$	110		$\text{ns}$		
$E_{on}$	Turn on Energy	$V_{CC}=600\text{V}, I_C=150\text{A}$ $R_G=3.6\Omega,$ $V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=125^\circ\text{C}$	27.2		$\text{mJ}$	
			$T_J=150^\circ\text{C}$	29.9		$\text{mJ}$	
$E_{off}$	Turn off Energy		$T_J=125^\circ\text{C}$	9.6		$\text{mJ}$	
			$T_J=150^\circ\text{C}$	10.1		$\text{mJ}$	
$I_{SC}$	Short Circuit Current		$tp_{sc} \leq 10\mu\text{S}, V_{GE}=15\text{V}$ $T_J=150^\circ\text{C}, V_{CC}=800\text{V}$		900		A
$R_{thJC}$	Junction to Case Thermal Resistance ( Per IGBT)				0.16	$\text{K/W}$	

## Diode-inverter

### ELECTRICAL CHARACTERISTICS ( $T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
$V_F$	Forward Voltage	$I_F=150\text{A}, V_{GE}=0\text{V}, T_J=25^\circ\text{C}$		1.75	2.15	V
		$I_F=150\text{A}, V_{GE}=0\text{V}, T_J=125^\circ\text{C}$		1.55		
		$I_F=150\text{A}, V_{GE}=0\text{V}, T_J=150^\circ\text{C}$		1.50		
$t_{rr}$	Reverse Recovery Time	$I_F=150\text{A}, V_R=600\text{V}$ $dI_F/dt=-2400\text{A}/\mu\text{s}$ $T_J=150^\circ\text{C}$		580		$\text{ns}$
$I_{RRM}$	Max. Reverse Recovery Current			152		A
$Q_{RR}$	Reverse Recovery Charge			34.7		$\mu\text{C}$
$E_{rec}$	Reverse Recovery Energy			11.6		$\text{mJ}$
$R_{thJCD}$	Junction to Case Thermal Resistance ( Per Diode)				0.3	$\text{K/W}$

# MMG150D120B6UC

## MODULE CHARACTERISTICS ( $T_C=25^{\circ}\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Values	Unit
$T_{Jmax}$	Max. Junction Temperature		175	$^{\circ}\text{C}$
$T_{Jop}$	Operating Temperature		-40~150	
$T_{stg}$	Storage Temperature		-40~125	
$V_{isol}$	Isolation Breakdown Voltage	AC, 50Hz(R.M.S), t=1minute	3000	V
CTI	Comparative Tracking Index		> 225	
Torque	to heatsink	Recommended (M6)	3~5	Nm
	to terminal	Recommended (M6)	2.5~5	Nm
Weight			300	g

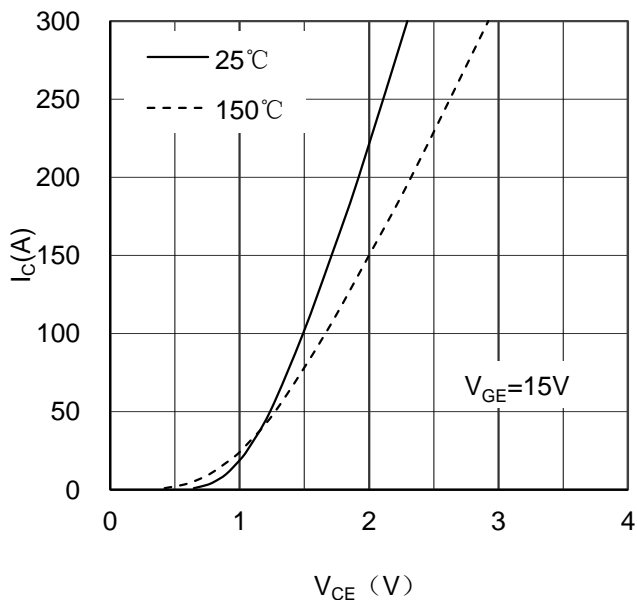


Figure 1. Typical Output Characteristics IGBT-inverter

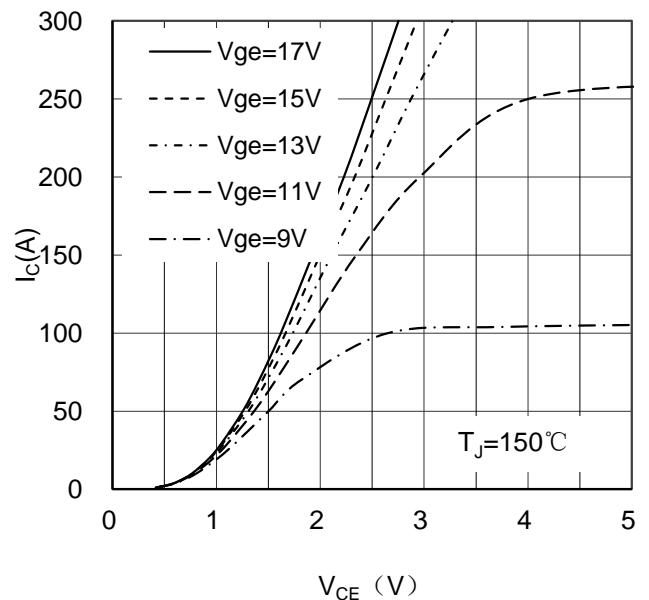


Figure 2. Typical Output Characteristics IGBT-inverter

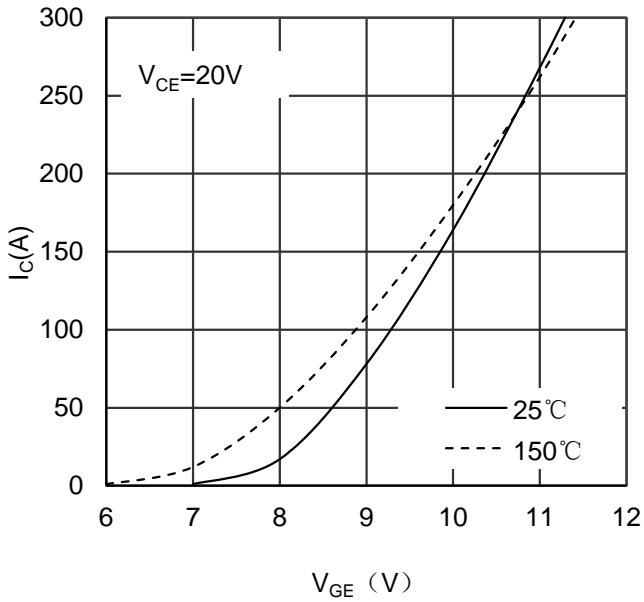


Figure 3. Typical Transfer characteristics IGBT-inverter

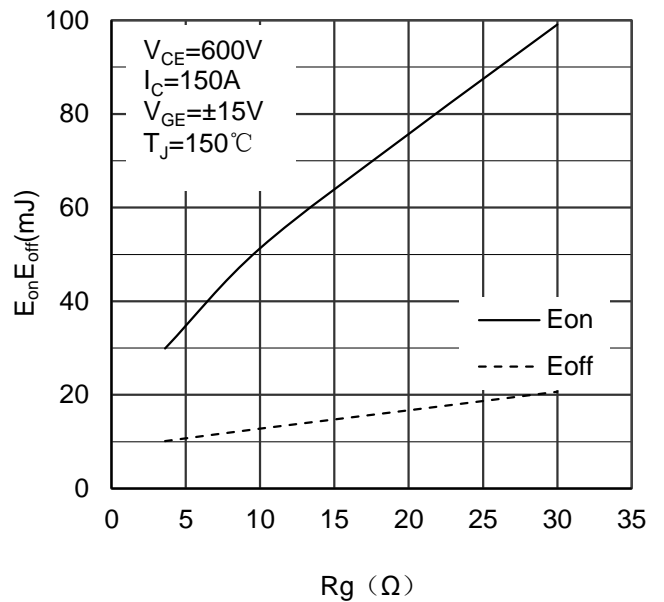


Figure 4. Switching Energy vs Gate Resistor IGBT-inverter

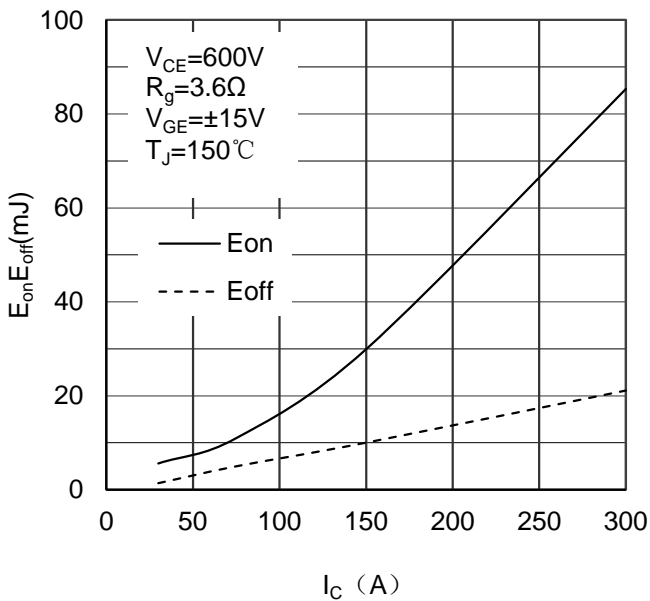


Figure 5. Switching Energy vs Collector Current IGBT-inverter

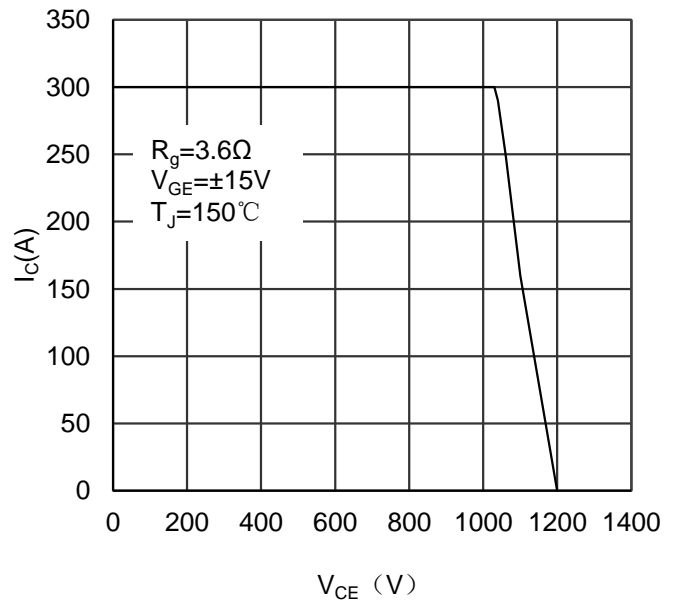


Figure 6. Reverse Biased Safe Operating Area IGBT-inverter

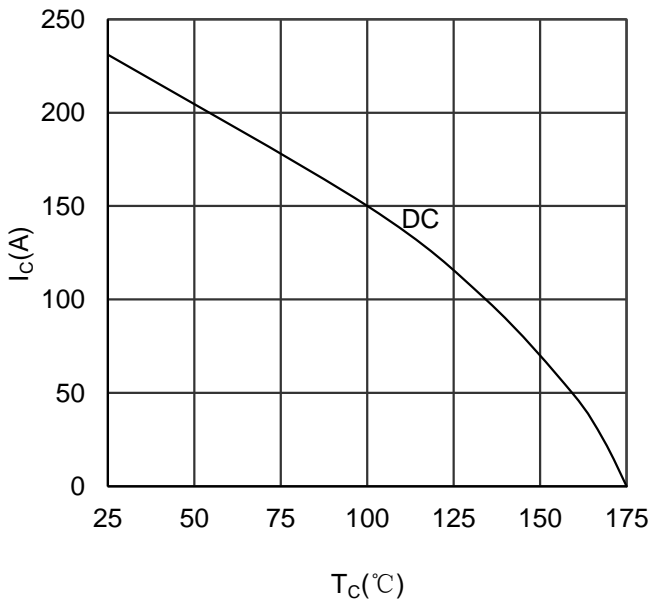


Figure 7. Collector Current vs Case temperature IGBT-inverter

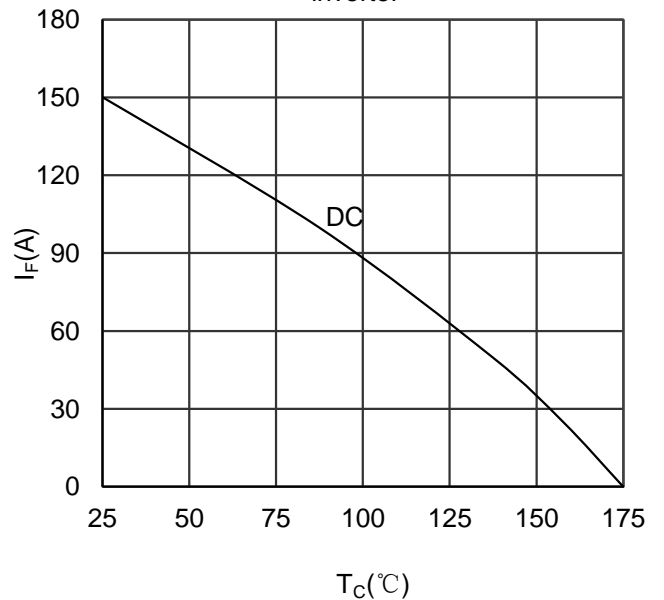


Figure 8. Forward current vs Case temperature Diode-inverter

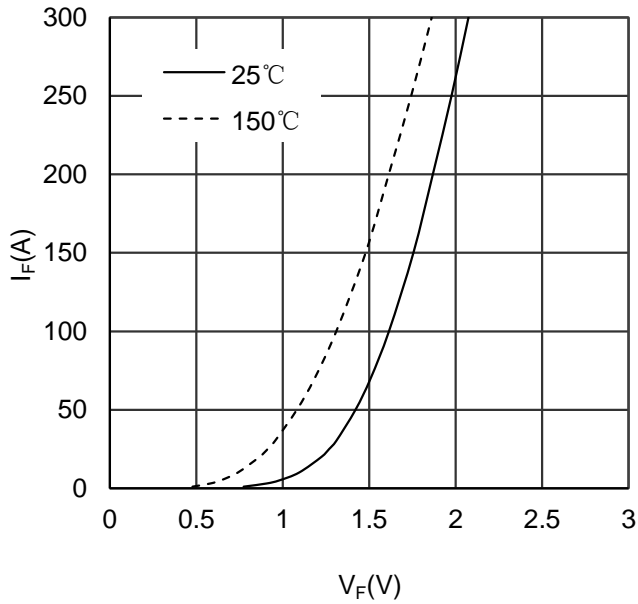


Figure 9. Diode Forward Characteristics Diode-inverter

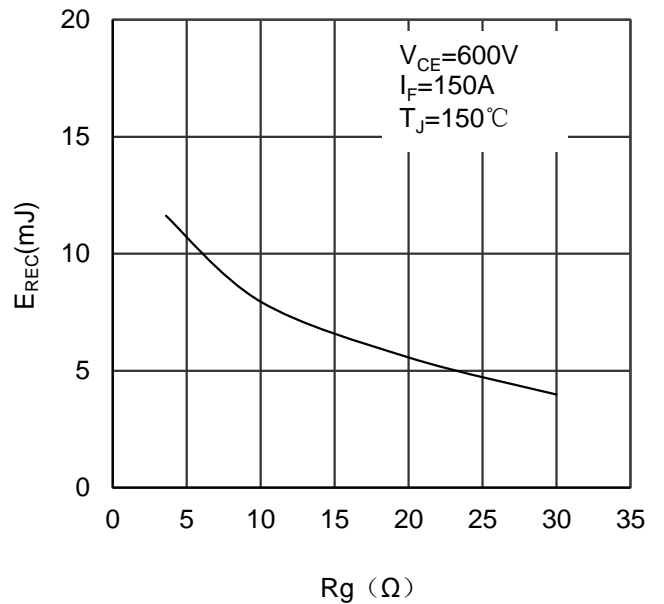


Figure 10. Switching Energy vs Gate Resistor Diode-inverter

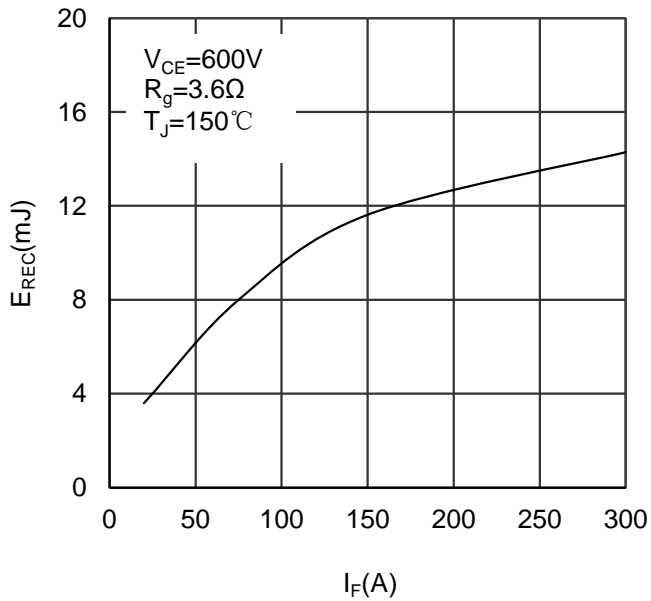


Figure 11. Switching Energy vs Forward Current Diode-inverter

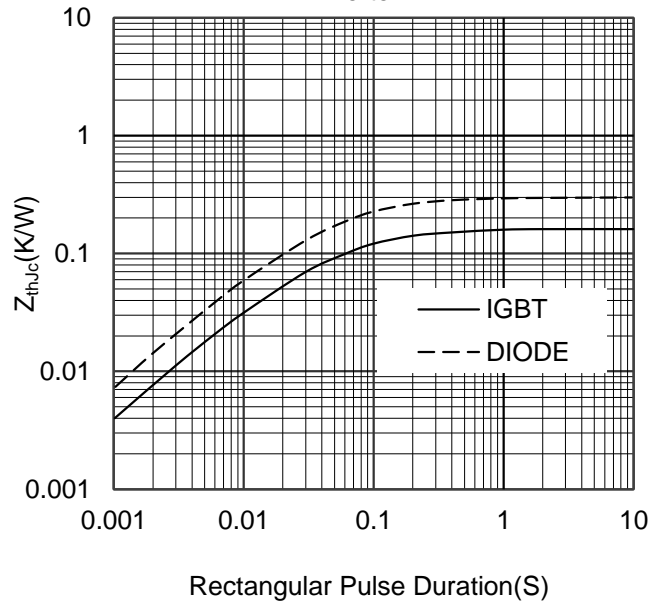


Figure 12. Transient Thermal Impedance of Diode and IGBT-inverter

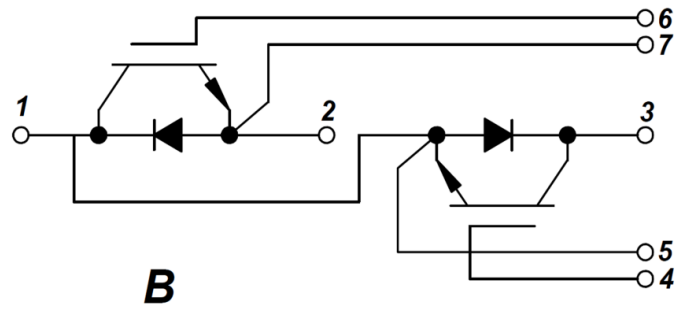
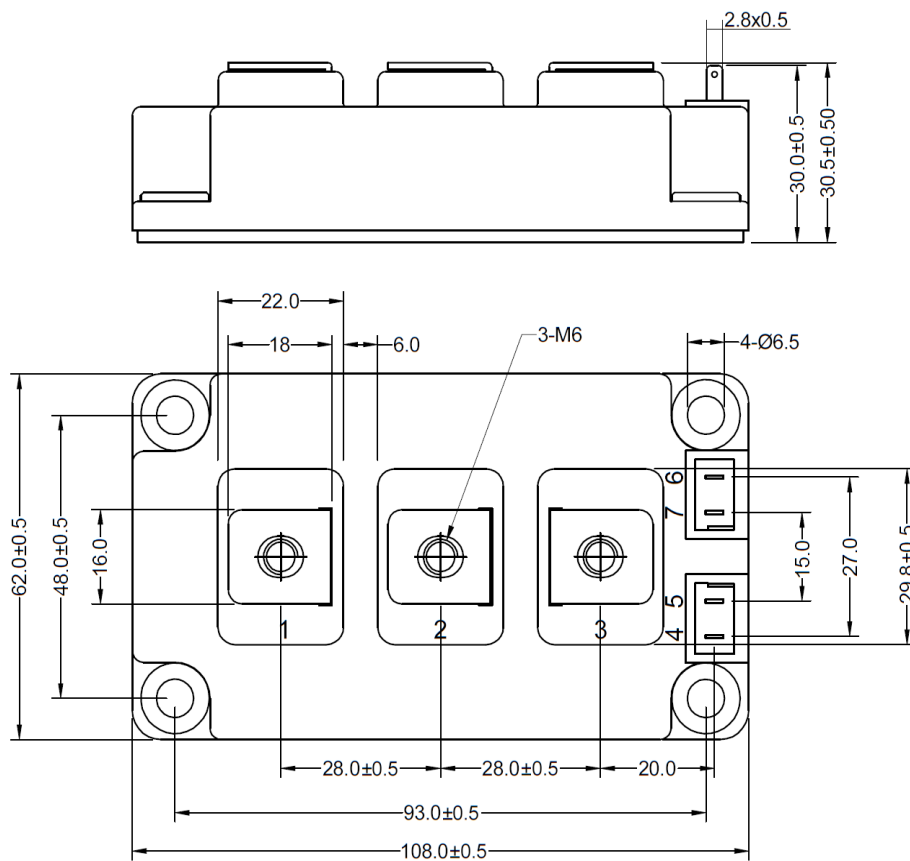


Figure 13. Circuit Diagram



Dimensions in (mm)  
Figure 14. Package Outline